JC14 Rec'd PCT/PTO 03 MAY 2005

513/

10-18-2005

Docket No: 112857-638

(Issue her see - man	U.S. DEPARTMENT OF COMMERCE U.S. Patent and Trademark Office 10/533529
To the Honorable Commissioner of Paterns and Trademarks: Please record the attached original documents or copy thereof.	
1. Name of conveying party(ies):	2. Name and address of receiving party(ies):
Tatsuo Itabashi	Name: Sony Corporation
	Internal Address:
Additional name(s) of conveying party(ies) attached? Yes x No	
3. Nature of conveyance:	Street Address: 7-35, Kitashinagawa 6-chome
<u>x</u> Assignment _ Merger	Shinagawa-ku
_ Security Agreement _ Change of Name	City: Tokyo State: Zip: 141-0032
_ Other	Country: Japan
Execution Date(s) March 22, 2005	Additional name(s) & address(es) attached? Yes x No
4. Application number(s) or patent number(s):	'
If this document is being filed together with a new application, the execution date of the application is: 03-22-2005	
A. Patent Application No.(s)	B. Patent No.(s)
Additional numbers attached? Yes X No	
5. Name and address of party to whom correspondence	6. Total number of applications and patents involved: 1
concerning document should be mailed:	7. Total fee (37 CFR 3.41)\$ 40.00
Thomas C. Basso	Enclosed
Bell, Boyd & Lloyd LLC P.O. Box 1135	x Authorized to be charged to deposit account
Chicago, Illinois 60690-1135	8. Deposit account number:
Fax: 312.827.8185	02-1818 (Attach duplicate copy of this page if paying by deposit account)
DO NOT USE THIS SPACE	
9. Statement and signature.	
To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a	
true copy of the original document. Thomas C. Passa (16.541)	Man 2 2005
Thomas C. Basso (46,541) Name of Person Signing	May 3, 2005 Signature Date
Total number of pages including cover sheet, attachments, and documents: 3	

Mail documents to be recorded with required cover sheet information to: Commissioner for Patents, Mail Stop Assignments, P.O. Box 1450, Alexandria, VA 22313-1450



Docket Number: 112857-638

ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in "COMMUNICATION PROCESSING DEVICE, COMMUNICATION PROCESSING METHOD, AND COMPUTER PROGRAM" for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35 Kitashinagawa, 6-Chome, Shinagawa-Ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for applications for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues or any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto.

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

Tokyo, Japan
Residence of first or sole hygentor

Signature of first or sole inventor

March 22, 2005

PATENT
RECORDED: 05/03/2005 REEL: 017082 FRAME: 0918